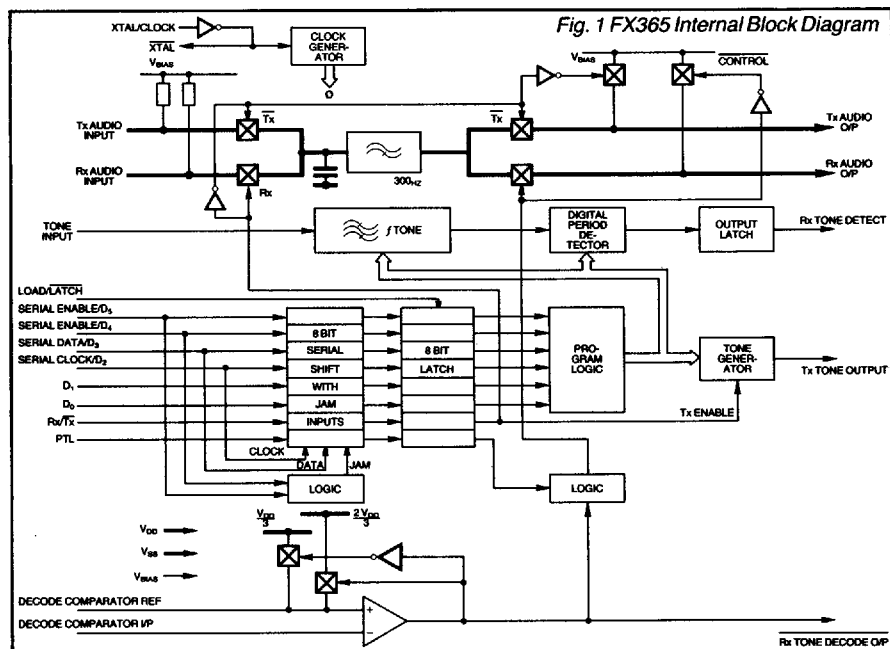


**Features/Applications****CONSUMER MICROCIRCUITS**

- CTCSS Encoder/Decoder
- Serial/Parallel μ P Interface
- 38 Programmable Tones
- Separate Rx/Tx Audio Paths
- HP Filter for Rejection of CTCSS Tone and Prefiltering of Tx Audio
- Low Falsing with Noise Inputs
- Tx Phase Reversal Facility

- 'No Tone' Facility
- HF Filters on Inputs
- On-Chip Analogue Switching
- Low Power 5V CMOS
- Xtal Controlled Tones
- Meets EIA RS220(B)/MPT1306
- Choice of DIL or Surface Mount Package Styles

**FX365****Brief Description**

The FX365 is a CMOS LSI device intended for use as a CTCSS Encoder/Decoder in radio communications systems. Designed specifically for microprocessor controlled multichannel equipment, the FX365 incorporates a number of advanced features which improve performance and facilitate system design. The tone frequency to be encoded or decoded, the transmit enable command and the monitor receiver audio command may all be entered via an 8-bit port and a load/latch pulse. Alternatively, the programming information may be entered via a serial data port and a data clock. The device has a new tone decoder design which reduces false decode outputs due to noise to insignificant levels.

The tone encoder has a phase reversal facility, the tone decoder and speech path high pass filter have separate inputs and both are protected against the effects of incident RF voltages. The speech path filter has low passband ripple, low output noise and a cut-off frequency of 300Hz regardless of the programmed CTCSS tone.

Separate Rx and Tx audio paths are provided for prefiltering of Tx audio and rejection of the CTCSS tone in Rx mode.

The FX365 uses a 1MHz crystal reference oscillator, a single 5-volt supply; and the choice of DIL or SMT packages makes it suitable for fixed or portable equipment.

Pin Number

Function

DIL FX365J	Quad Plastic FX365LG	PLCC FX365LS
1	1	1
2	2	2
3	3	3
4	4	4
5	5	5
6	6	6
7	7	7
8	8	8
9	9	9
10	10	10
11	11	11
12	12	12
13	13	13

CONSUMER MICROCIRCUITS

V_{DD}: Positive Supply.

Xtal/Clock I/P: Input to on-chip inverter used with a 1MHz Xtal or external clock source.

Xtal: Output of on-chip inverter (clock output).

Load/Latch: Controls 8 on-chip latches and is used to latch Rx/Tx, PTL, D₀-D₅. This pin is internally pulled to V_{DD}. A logic '1' applied to this input puts the 8 latches in 'transparent' mode. A logic '0' applied to this input puts the 8 latches in the 'latched' mode. In parallel mode data is loaded and latched by a logic 1 → 0 transition (see Fig. 4). In serial mode data is loaded and latched by a 0 → 1 → 0 strobe pulse on this pin (see Fig. 5).

D₅/Serial Enable 1: Data input D₅ (in parallel mode). A logic '1' applied to this input together with a logic '0' applied to D₄/SERIAL ENABLE 2 will put the device in 'Serial mode' (see Fig. 5). This pin internally pulled to V_{DD}.

D₄/Serial Enable 2: Data input D₄ (in parallel mode). A logic '0' applied to this input together with a logic '1' on pin 5 will place the device in 'serial mode' (see Fig. 5). This pin internally pulled to V_{DD}.

D₃/Serial Data: Data input D₃ (in parallel mode). In serial mode this pin becomes the serial data input for D₅-D₀, Rx/Tx, PTL (see Fig. 5). D₅ is clocked first and PTL last. This pin internally pulled to V_{DD}.

D₂/Serial Clock: Data D₂ (in parallel mode). In serial mode this pin becomes the serial clock input. Data is clocked on the positive going edge (see Fig. 5). This pin is internally pulled to V_{DD}.

D₁: Data D₁ (in parallel mode). This pin internally pulled to V_{DD}.

D₀: Data D₀ (in parallel mode). This pin internally pulled to V_{DD}.

V_{SS}: Negative supply.

Decode Comparator Ref (I/P): This pin is internally biased to V_{DD}/3 or 2V_{DD}/3 via 1MΩ resistors depending on the logical state of the TONE DECODE O/P pin. TONE DEC O/P = 1 will bias this input to 2V_{DD}/3, a logic '0' will bias this input to V_{DD}/3. This input provides the decode comparator reference voltage, and switching of bias voltages provides hysteresis to reduce 'chatter' under marginal conditions.

Rx Tone Decoder (O/P): Gated output of the decode comparator. This output is used to gate the Rx Audio path. A logic '0' on this pin indicates a successful decode and indicates that the 'decode comparator input' pin is more positive than the 'decode comparator ref' input (see Table 2).

Pin Number

Function

DIL FX365J	Quad Plastic FX365LG	PLCC FX365LS
14	14	14
15	15	15
16	16	16
17	17	17
18	18	18
19	19	19
20	20	20
21	21	21
22	22	22
23	23	23
24	24	24

CONSUMER MICROCIRCUITS

Decode Comparator Input: This is the inverting input of the decode comparator. This pin is to be connected to the Rx TONE DETECT pin via an external integrator (see Figs. 2 & 3).

Rx Tone Detect (O/P): In Rx mode this pin will go to logic '1' during a successful decode (see Table 2). This pin is normally connected to the Decode Comparator input via the external integrator circuitry, as shown in Figs. 2 & 3.

Tx Tone O/P: A low impedance emitter follower stage for sourcing the CTCSS sinewave under the control of the Rx/Tx pin. This O/P when not transmitting a tone may be biased to $\frac{V_{DD} - 0.7V}{2}$ or O/C (see Table 2).

Rx/Tx: This input (in parallel mode) selects Rx or Tx modes (see Fig. 2). In serial mode this function is serially loaded. This pin is internally pulled to V_{DD} via a 1M Ω resistor.

PTL: In parallel Rx mode this pin operates as a 'press to listen' function by enabling the Rx audio path thus overriding the tone squelch function. In parallel Tx mode this pin reverses the phase of the transmitted CTCSS tone (squelch tail elimination). In serial mode this function is serially loaded (see Fig. 3). The phase reversal function should be applied by timing circuit to ensure correct system operation.

Rx Audio Out: This is the high pass filtered "Receive" audio output pin. This pin outputs audio when Rx TONE DECODE=0, or PTL=1 or NOTONE is programmed (see Table 2). In Tx mode this pin is biased to $\frac{V_{DD}}{2}$.

Tx Audio Out: This is the high pass filtered "Transmit" audio output pin. In Tx mode this pin outputs audio present at the 'Tx AUDIO INPUT' pin. In Rx mode this pin is biased to $\frac{V_{DD}}{2}$.

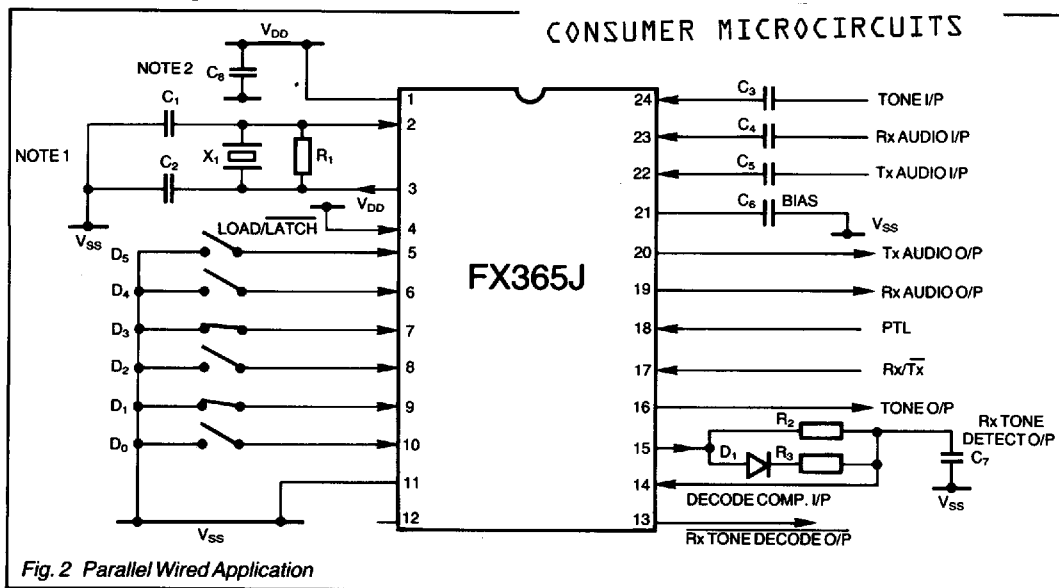
Bias: This pin is the output of an internally generated $\frac{V_{DD}}{2}$ bias level and would normally be externally decoupled to V_{SS} via C_6 .

Tx Audio I/P: This is the Tx Audio input pin. In Tx mode audio may be prefiltered, using the Tx audio path, thus helping to avoid talkoff due to intermodulation of speech frequencies with the transmitted CTCSS tone. The Tx audio path may also be used to prefilter speech when using scramblers which introduce noise in the low frequency band. This pin is internally biased to $\frac{V_{DD}}{2}$.

Rx Audio Input: This is the input to the audio high pass filter in Rx mode. This pin is internally biased to $\frac{V_{DD}}{2}$.

Tone Input: This is the input to the CTCSS tone detector and is internally biased to $\frac{V_{DD}}{2}$.

External Component Connections



Component	Unit Value	Note
R ₁	1M	1
R ₂	820k	
R ₃	330k	
C ₁	68p	1
C ₂	33p	1
C ₃	0.1μ	
C ₄	0.1μ	

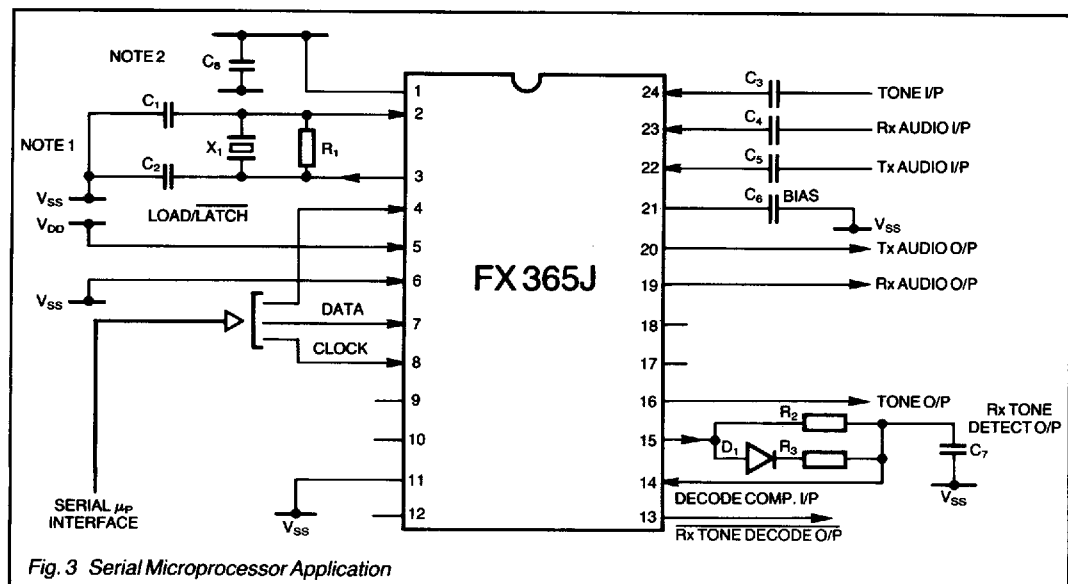
NOTES:

Tolerances: Resistors $\pm 10\%$. Capacitors $\pm 20\%$
 1. Xtal circuitry shown is in accordance with CML.
 Application Note D/XT/1 April 1986.

Component	Unit Value	Note
C ₅	0.1μ	
C ₆	1.0μ	
C ₇	0.1μ	
C ₈	1.0μ	2
D ₁	small signal	
X ₁	1MHz	1

2. C₈ is used for power supply decoupling.
 Depending on application further filtering may be required.

Table 1 Component References and Values



Truth Tables

T-75-27-90

Input Pin – Condition				Output Pin – Condition		Result/Function					Notes
D ₀ -D ₅	Rx/Tx	PTL	Decode Comp Input	Rx Tone Detect	Tone Decode	Tone Transmitter Enabled	Tx Tone Phase Reversed	Tx Audio Path Enabled	Tone Decoder Enabled	Rx Audio Path Enabled	
Tone	0	0	x	0	1	Yes	No	Yes	No	No (bias)	1a
Tone	0	1	x	0	1	Yes	Yes	Yes	No	No (bias)	1b
No tone	0	x	x	0	1	No (bias)	x	Yes	No	No (bias)	2
Tone	1	0	0	0	1	No (o/c)	x	No	Yes	No (bias)	3a
Tone	1	1	0	0	1	No (o/c)	x	No	Yes	Yes	3b
Tone	1	x	1	1	0	No (o/c)	x	No	Yes	Yes	4
No tone	1	x	x	x	0	No (o/c)	x	No	Yes	Yes	5

Notes:

- 1a. Normal tone transmit condition.
 1b. Tone transmit with phase reversed.
 2. 'NOTONE' programmed in Tx mode, tone transmit O/P set to $V_{DD}/2 - 0.7V$. Tx audio path enabled.
 3a. Normal decode standby.
 3b. Normal decode standby with PTL used to enable audio.
 4. Normal 'decode of correct CTCSS tone' condition, PTL has no effect.
 5. 'NOTONE' programmed in Rx mode, tone transmit O/P (o/c), Rx audio path enabled.

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Table 2 Truth table defining combinations of input/output conditions.

Nominal		FX365		Programme Inputs						
Freq. Hz	Frequency	$\Delta f, \%$	D ₀	D ₁	D ₂	D ₃	D ₄	D ₅		
67.0	67.05	+0.07	1	1	1	1	1	1		
71.9	71.90	0.0	1	1	1	1	1	0		
74.4	74.35	-0.07	0	1	1	1	1	1		
77.0	76.96	-0.05	1	1	1	1	0	0		
79.7	79.77	+0.09	1	0	1	1	1	1		
82.5	82.59	+0.10	0	1	1	1	1	0		
85.4	85.38	-0.02	0	0	1	1	1	1		
88.5	88.61	+0.13	0	1	1	1	0	0		
91.5	91.58	+0.09	1	1	0	1	1	1		
94.8	94.76	-0.04	1	0	1	1	1	0		
97.4	97.29	-0.11	0	1	0	1	1	1		
100.0	99.96	-0.04	1	0	1	1	0	0		
103.5	103.43	-0.07	0	0	1	1	1	0		
107.2	107.15	-0.05	0	0	1	1	0	0		
110.9	110.77	-0.12	1	1	0	1	1	0		
114.8	114.64	-0.14	1	1	0	1	0	0		
118.8	118.80	0.0	0	1	0	1	1	0		
123.0	122.80	-0.17	0	1	0	1	0	0		
127.3	127.08	-0.17	1	0	0	1	1	0		
131.8	131.67	-0.10	1	0	0	1	0	0		
136.5	136.61	+0.08	0	0	0	1	1	0		
141.3	141.32	+0.02	0	0	0	1	0	0		
146.2	146.37	+0.12	1	1	1	0	1	0		
151.4	151.09	-0.20	1	1	1	0	0	0		
156.7	156.88	+0.11	0	1	1	0	1	0		
162.2	162.31	+0.07	0	1	1	0	0	0		
167.9	168.14	+0.14	1	0	1	0	1	0		
173.8	173.48	-0.19	1	0	1	0	0	0		
179.9	180.15	+0.14	0	0	1	0	1	0		
186.2	186.29	+0.05	0	0	1	0	0	0		
192.8	192.86	+0.03	1	1	0	0	1	0		
203.5	203.65	+0.07	1	1	0	0	0	0		
210.7	210.17	-0.25	0	1	0	0	1	0		
218.1	218.58	+0.22	0	1	0	0	0	0		
225.7	226.12	+0.18	1	0	0	0	1	0		
233.6	234.19	+0.25	1	0	0	0	0	0		
241.8	241.08	-0.30	0	0	0	0	1	0		
250.3	250.28	-0.01	0	0	0	0	0	0		
Notone	Notone	—	0	0	0	0	1	1		
Serial Input Mode			x	x	Clock	Data	0	1		

Table 3 Tone programming Truth table

Parallel and Serial Mode Timing Diagrams

CONSUMER MICROCIRCUITS

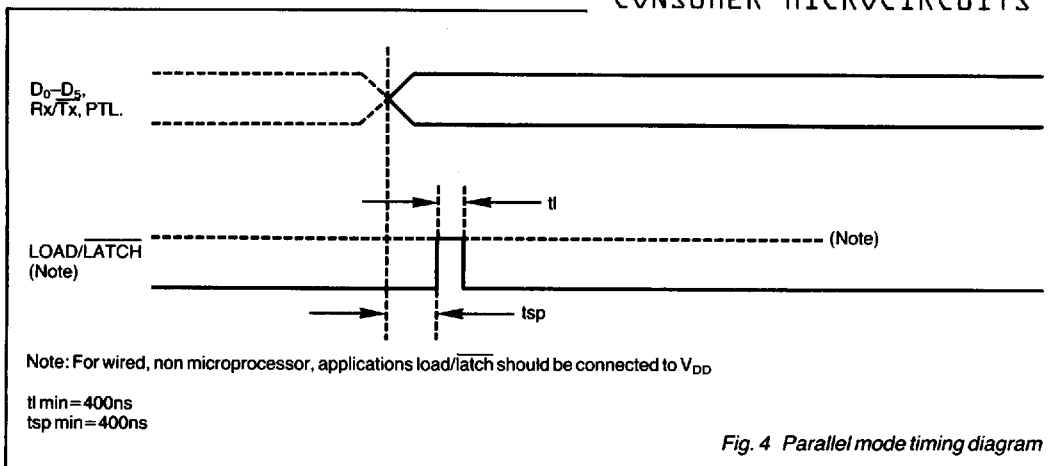


Fig. 4 Parallel mode timing diagram

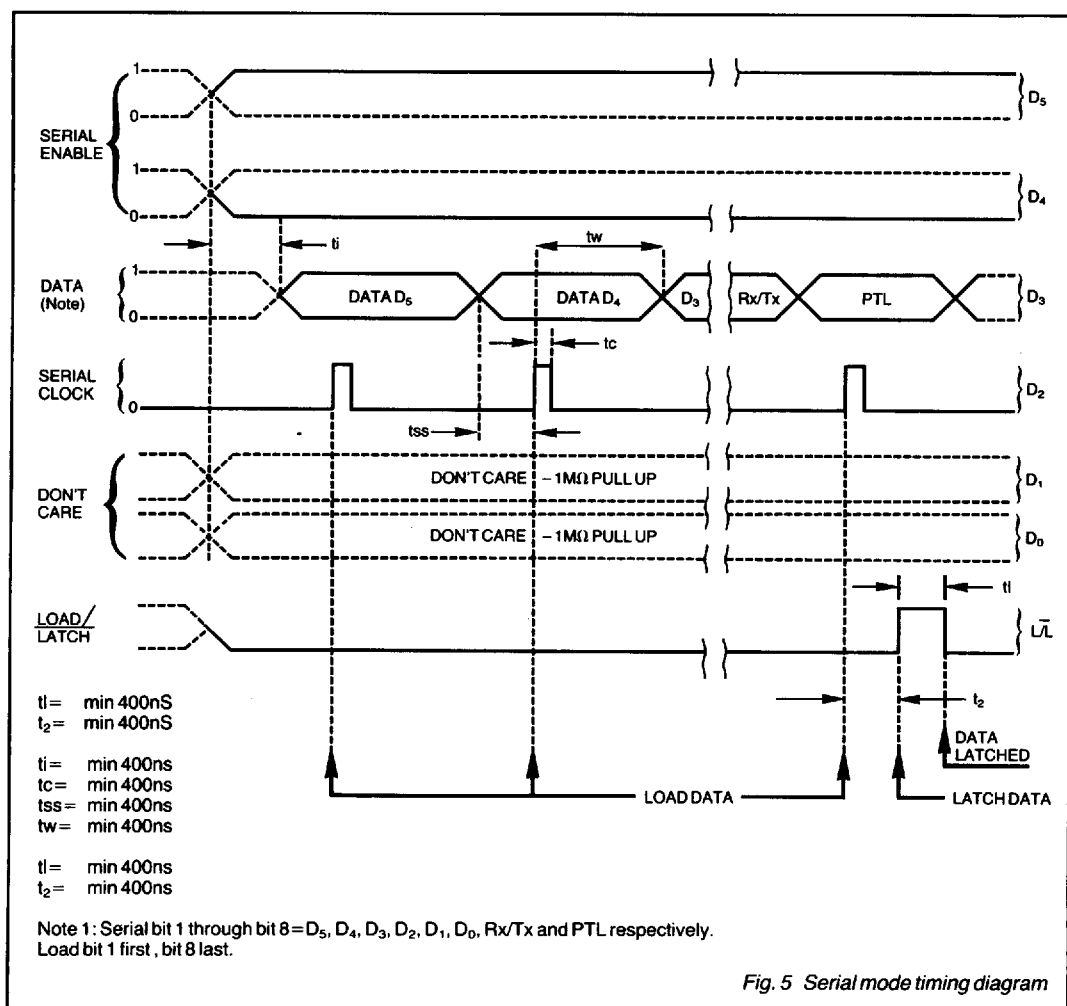


Fig. 5 Serial mode timing diagram

Specification**CONSUMER MICROCIRCUITS****Absolute Maximum Ratings**

Exceeding the maximum rating can result in device damage. Operation of the device outside the operating limits is not implied.

Supply voltage	-0.3V to 7.0V
Input voltage at any pin (ref $V_{SS}=0V$)	-0.3V to ($V_{DD}+0.3V$)
Output sink/source current (total)	20mA
Operating temperature range:	FX365J -30°C to +85°C
	FX365LG/LS -30°C to +70°C
Storage temperature range:	FX365J -55°C to +125°C
	FX365LG/LS -40°C to +85°C
Maximum device dissipation	800mW
Derating	10mW/°C

Operating Limits

All device characteristics are measured under the following conditions unless otherwise specified:

$V_{DD} = 5.0V$, $T_{AMB} = 25°C$, 0dB ref: = 300mVrms. Composite Signal = 0dB 1kHz Tone, -12dB Noise (band-limited 6kHz gaussian white noise), -20dB f_0 CTCSS Tone.

Characteristics	See Note	Min.	Typ.	Max.	Unit
Static Characteristics					
Supply Voltage		4.5	5.0	5.5	V
Supply Current					
(Tx)		-	3.5	-	mA
(Rx)		-	3.5	-	mA
Tone Input Impedance		-	1.0	-	MΩ
Audio Input Impedance		-	1.0	-	MΩ
Audio Output Impedance		-	1.0	-	kΩ
Digital Input Impedance	1	-	1.0	-	MΩ
Input Logic "1"	1	3.5	-	-	V
Input Logic "0"	1	-	-	1.5	V
Logic "1" Output 1' source = 0.1mA	2	4.0	-	-	V
Logic "0" Output 1' sink = 0.1 mA	2	-	-	1.0	V
Dynamic Characteristics					
Decoder					
Decode Input Signal Level	3	-20	-	-	dB
Decode Response Time	3, 6	-	-	250	ms
De-Response Time	3, 6	-	-	250	ms
Decode Selectivity	3	±0.5	-	±3.0	% f_0
Encoder					
Tone Output Level (relative 775mVrms)		-3.0	0	-	dB
Tone Frequency Accuracy (f_0 error)		-0.3	-	+0.3	% f_0
Risetime to 90% (nominal output)					
$f_0 > 100Hz$	4	-	55.0	-	ms
$f_0 < 100Hz$	4	-	70.0	-	ms
Tone Output Load Current		-	-	5.0	mA
Total Harmonic Distortion		-	2.0	5.0	%
Output Level Variation Between Tones		-	0.1	-	dB
Audio Filter					
Total Harmonic Distortion	5	-	2.0	5.0	%
Output Noise Level					
Input a.c. Short Cct, Audio Switch Enabled		-	-49.0	-45.0	dB
Cut-Off frequency		-	300	-	Hz
Bandpass Ripple (300Hz -3000Hz)	5	-1.0	-	+1.0	dB
Stopband Attenuation <250Hz	5	36.0	40.0	-	dB
Passband Gain (ref. 1kHz)		-	0	-	dB
Audio Switch					
Isolation	5	-	60.0	-	dB
Serial/Parallel Inputs					
Parallel Set-Up Time (t_{sp})	7	400	-	-	ns
Load/Latch Pulse Width (t_l)	7	400	-	-	ns
Serial Clock Pulse Width (t_c)	7	400	-	-	ns
Serial Set-Up Time (t_{ss})	7	400	-	-	ns
Serial Clock Frequency	7	-	1.0	-	MHz

Notes

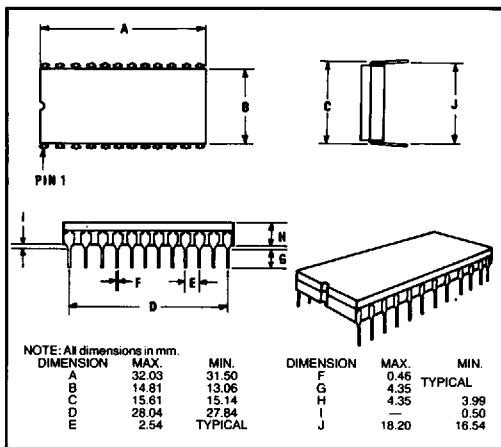
- Refers to Rx/Tx, PTL, Decode Comparator Input, D_0 , D_1 , D_2 , D_3 , D_4 , D_5 .
- All logic outputs.
- Composite Signal Test Condition.
- Any programme tone and RL = 600Ω. CL = 15pF. Includes response to a phase reversal instruction.
- 1kHz reference = 0dB.
- $f_0 > 100Hz$, (for 100Hz $> f_0 > 67Hz$: $t = (100/f_0 \text{ Hz}) \times 250ms$).
- See Figures 4 and 5.

Packaging Outlines

The FX365J, the cerdip package, is illustrated in figure 6. The 'LG' version is shown in figure 7, and the 'LS' version in figure 8. To allow complete identification, the FX365 LG and 'LS' packages have an indent spot adjacent to pin 1 and a chamfered corner between pins 3 and 4. Pins number anti-clockwise when viewed from the top (indent side).

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Fig. 6 **FX365J** Cerdip DIL Package



Ordering Information

- FX365J** 24-pin cerdip DIL
FX365LG 24-pin quad plastic encapsulated, bent and cropped
FX365LS 24-lead plastic leaded chip carrier

Handling Precautions

The FX365J/LG/LS is a CMOS LSI circuit which includes input protection. However, precautions should be taken to prevent static discharges which may cause damage.

Fig. 7 **FX365LG** Package

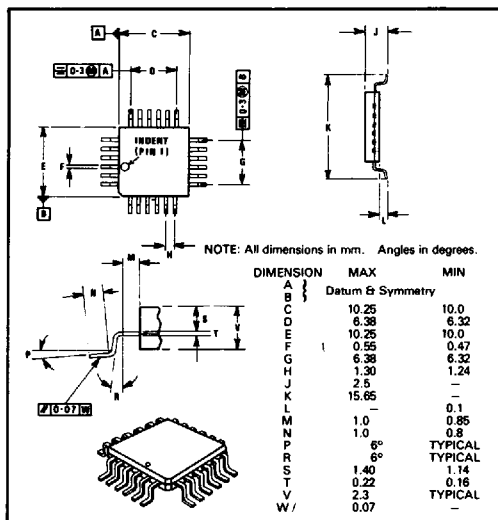
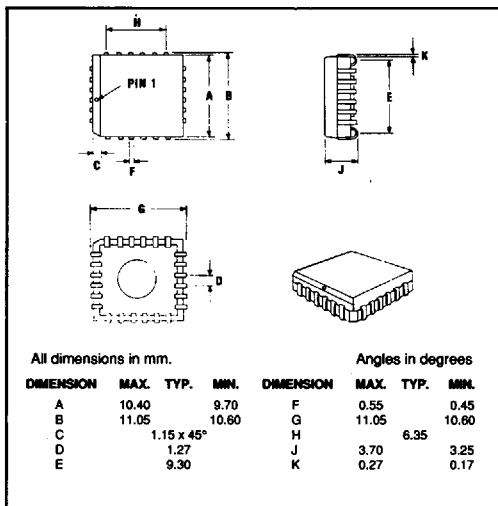


Fig. 8 **FX365LS** Package



CML does not assume any responsibility for the use of any circuitry described. No circuit patent licences are implied and CML reserves the right at any time without notice to change the said circuitry.

Integrated Circuits Data Book

T-90-20

Section 11

CONSUMER MICROCIRCUITS

Packaging and Applications

CML Packaging	11.2
Handling Precautions	11.6
Xtal Oscillator Circuits	11.7

CML Packaging**CONSUMER MICROCIRCUITS**

For ease and convenience CML products are packaged for despatch in industry standard bulk or individual packaging as described below.

- Trays (17cm x 10.5cm) and cardboard boxes with conductive foam.
- 50-pocket conductive trays for surface-mount microcircuits.
- Anti-static coated tubes, of various sizes, with thumbplugs.
- 13-inch reel Tape-and-Reel packaging which fully conforms to the latest EIC specification.
The conductive embossed tape provides a secure cavity sealed with a peel-back cover tape.
500 units/reel – no partial reel counts are available.

T-90-20

CML Tape and Reel Specification**1. Scope**

The specification relates to the tape packaging of integrated circuits suitable for use in "surface mount" assembly. It includes only those dimensions which are essential for the purchaser to use the product.

2. Dimensions (Refer to Figures 1a, 1b and 1c)

2.1 Tape width	$W = 24 \pm 0.3\text{mm}$	2.9 Embossed Tape Dimension K_o	
2.2 Carrier Tape Thickness	$t = 0.3\text{mm Max.}$	2.9.1 LG	$K_o = 2.8 \pm 0.1\text{mm}$
2.3 Pitch of Sprocket Holes	$P_o = 4.0 \pm 0.1\text{mm}$	2.9.2 LH	$K_o = 4.9 \pm 0.1\text{mm}$
2.4 Diameter of Sprocket Holes	$D = 1.5 \pm 0.1\text{mm}$ $1.5 - 0.00\text{mm}$	2.9.3 LS	$K_o = 4.3 \pm 0.1\text{mm}$
2.5 Distance	$E = 1.75 \pm 0.1\text{mm}$	2.10 Pitch of Component Compartments	
2.6 Distance, centre to centre	$F = 11.5 \pm 0.1\text{mm}$	2.10.1 LG	$P = 20 \pm 0.1\text{mm}$
2.7 Dimension, centre to centre		2.10.2 LH	$P = 16 \pm 0.1\text{mm}$
2.7.1 LG	$P_2 = 10 \pm 0.1\text{mm}$	2.10.3 LS	$P = 16 \pm 0.1\text{mm}$
2.7.2 LH	$P_2 = 6 \pm 0.1\text{mm}$	2.11 Outside Dimension of Pocket	
2.7.3 LS	$P_2 = 6 \pm 0.1\text{mm}$	2.11.1 LG	$B_1 = 16.4 \pm 0.1\text{mm}$
2.8 Embossed Pocket Dimension A_o and B_o		2.11.2 LH	$B_1 = 13.8 \pm 0.1\text{mm}$
2.8.1 LG	$A_o = 15.8 \pm 0.1\text{mm}$	2.11.3 LS	$B_1 = 12.3 \pm 0.1\text{mm}$
2.8.2 LG	$B_o = 15.8 \pm 0.1\text{mm}$	2.12 Pocket Centre Holes	
2.8.3 LH	$A_o = 13.1 \pm 0.1\text{mm}$	2.12.1 LG	$D_1 = 2.0\text{mm Min.}$
2.8.4 LH	$B_o = 13.1 \pm 0.1\text{mm}$	2.12.2 LH	$D_1 = 2.0\text{mm Min.}$
2.8.5 LS	$A_o = 11.7 \pm 0.1\text{mm}$	2.12.3 LS	$D_1 = 2.0\text{mm Min.}$
2.8.6 LS	$B_o = 11.7 \pm 0.1\text{mm}$		

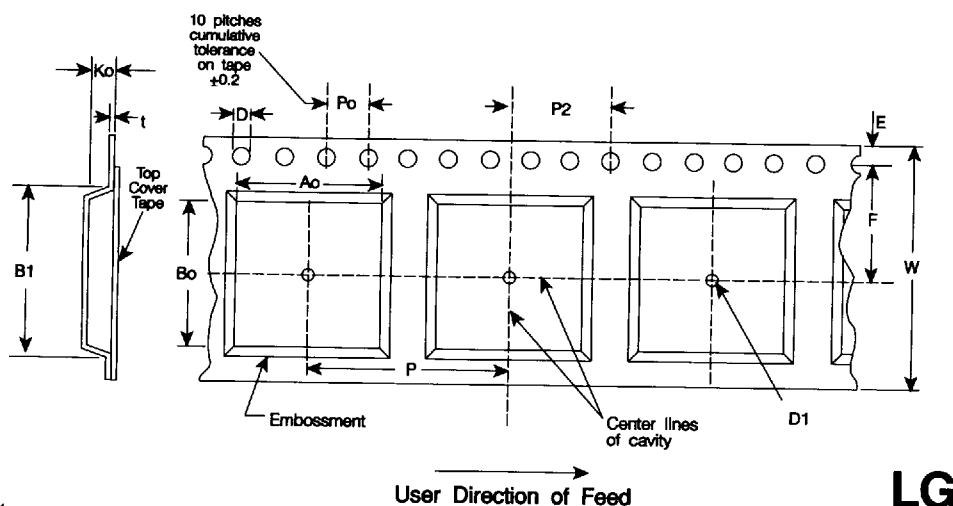


Fig.1a

CML Packaging

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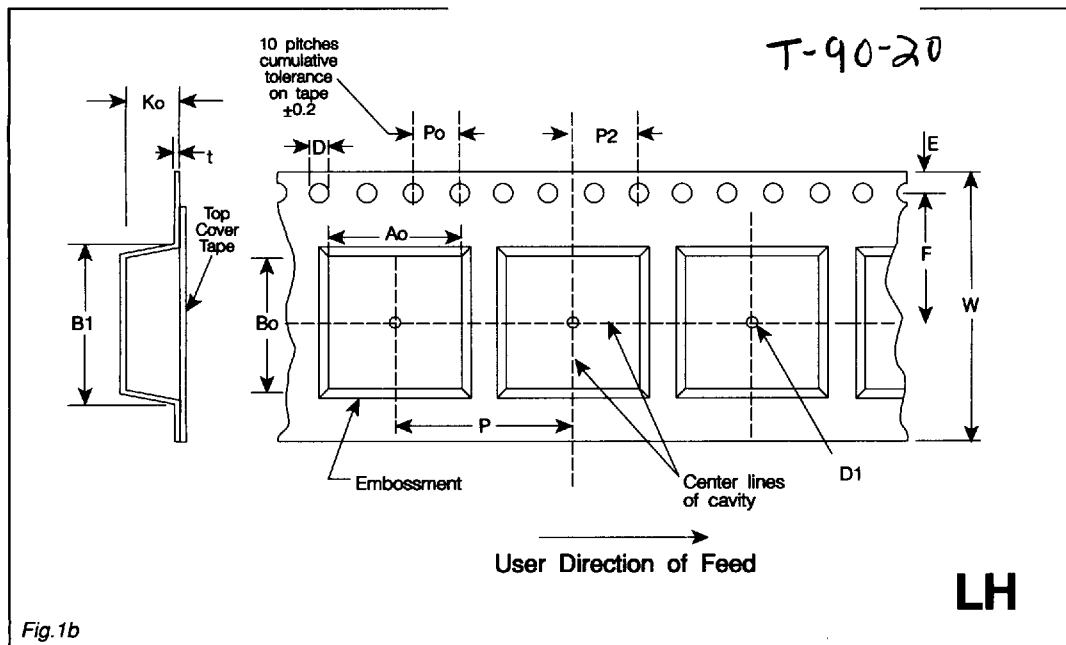


Fig.1b

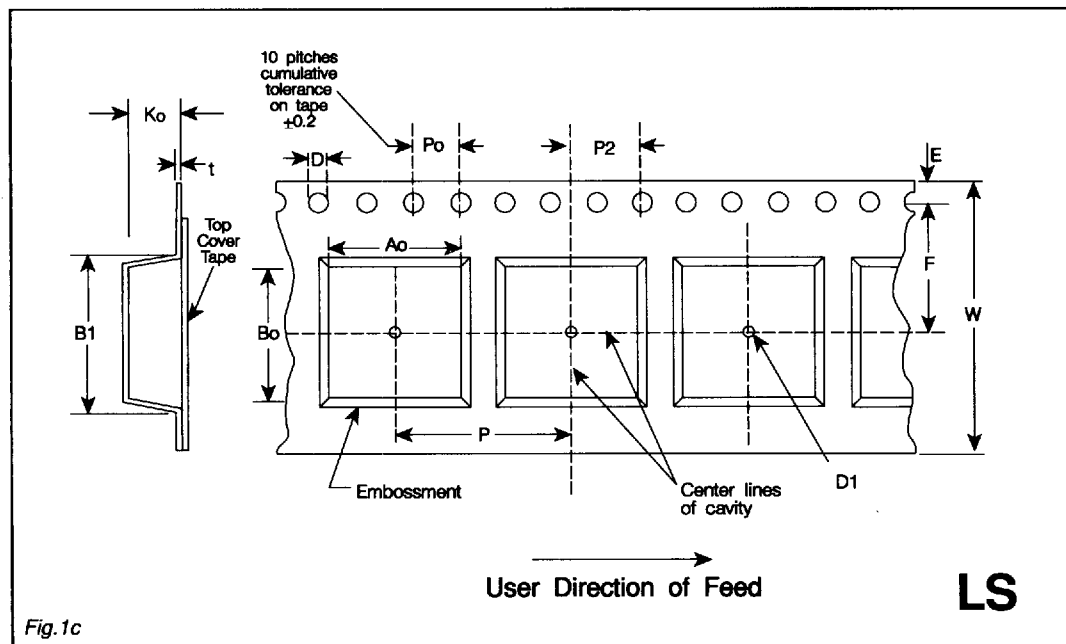


Fig.1c

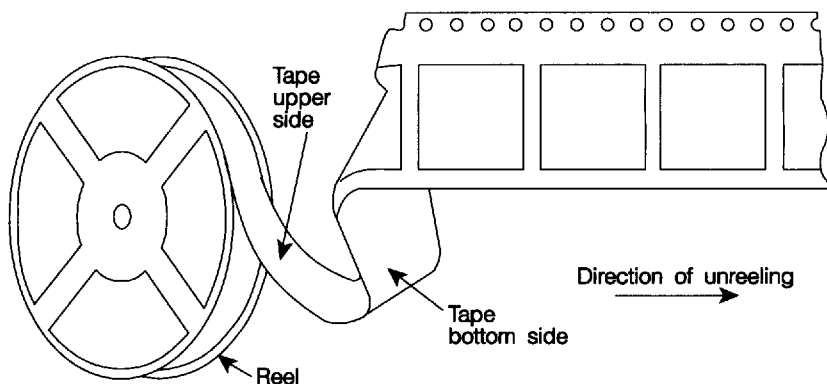


Fig.2 Tape Top and Bottom Orientation

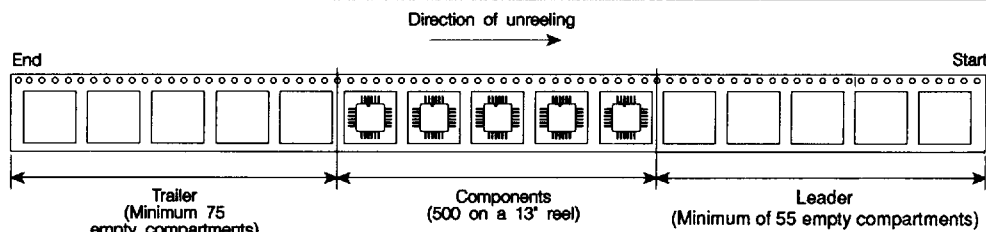


Fig.3 Layout of Tape

3. Materials

- 3.1 Carrier tape to be made of a conductive grade of polystyrene.
- 3.2 Conductive polycarbonate is also an approved carrier tape material and may be used under certain circumstances.
- 3.3 Cover tape is an anti-static grade of polypropylene/polyester film with a strip of pressure sensitive adhesive approximately 1mm wide along each edge.

4. Polarity and Orientation of Components in Tape

- 4.1 All components will be placed such that Pin 1 is adjacent to the sprocket holes (See Figures 6a and 6b).
- 4.2 The mounting side of the component shall be oriented to the bottom side of the tape (See Figure 2).

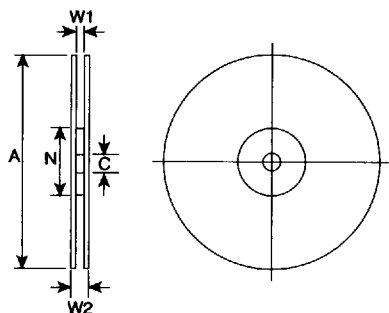


Fig.4 Reel Dimensions

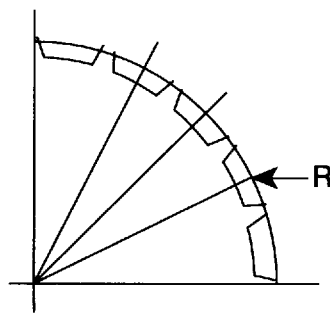
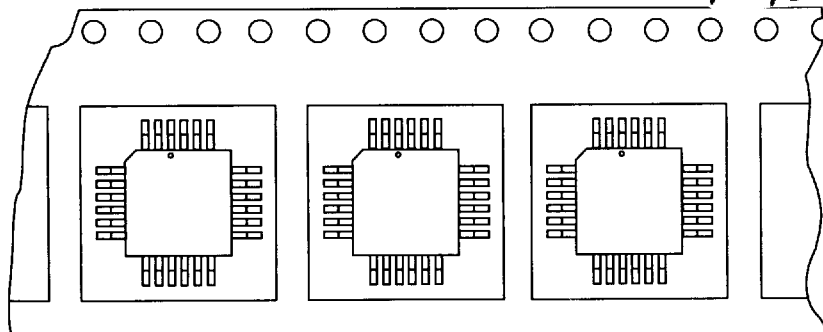


Fig.5 Minimum Radius = 30mm

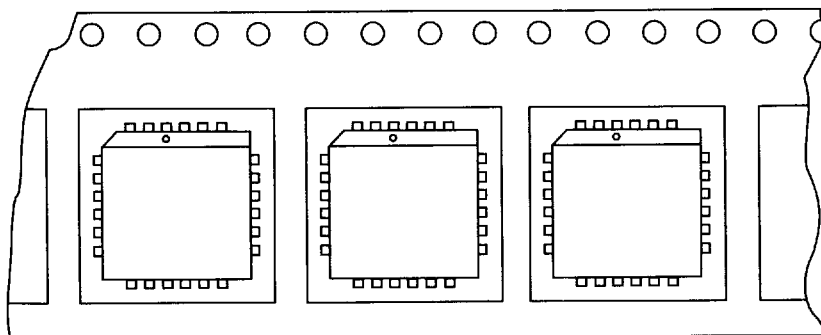
T-90-20

Fig.6a



User direction of feed

Fig.6b



User direction of feed

Fig.6 Component Orientation

5. Fixing of Components in Tape

- 5.1 Cover tapes shall not cover the sprocket holes.
- 5.2 Tapes in adjacent layers shall not stick together in the packing.
- 5.3 The adhesive of the cover tape shall not adversely effect the mechanical and electrical characteristics and marking of the components.
- 5.4 Components shall not stick to the carrier tape or the cover tape.
- 5.5 The tapes shall be suitable to withstand storage of the taped components without danger or migration of the terminations or the giving off of vapours which would impair soldering or deteriorate the component properties or termination by chemical action.
- 5.6 When the tape is bent with a minimum radius (See Figure 5) of 30mm, the tape shall not be damaged and the components shall remain in their position and orientation in the tape.
- 5.7 The peel strength of the cover tape shall be 50 ± 25 grams measured at $175^\circ - 180^\circ$ with respect to the carrier tape along its longitudinal axis. The peel speed shall be 240mm/min.
- 5.8 After baking at 60°C for 48 hours or storage in ideal conditions for three months, the peel strength shall remain within the specified limits.

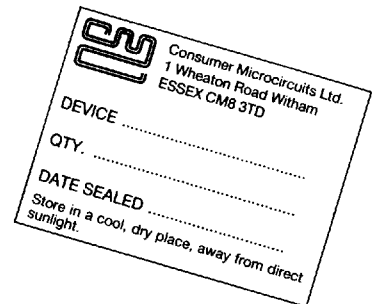
CML Packaging**CONSUMER MICROCIRCUITS***T-90-20***6. Packaging**

6.1 Tape will be wound on anti-static plastic reels (See Figure 4)

Dimensions

6.1.1	A	C	N	W1	W2
	Reel Dia.	Centre Hole	Hub Outer Dia.	Inside Cheek Width	Outside Cheek Width
	330mm	12.7mm	62.5mm	24.5mm	28.8mm

- 6.2 There will be a leader of a minimum of 55 empty compartments, at the start of the carrier tape (See Figure 3).
- 6.3 There will be no missing components between the first and last part of working tape in any reel.
- 6.4 At the end of the tape there will be a trailer of a minimum of 75 empty compartments (See Figure 3).
- 6.5 The tape shall release from the reel hub as the last portion of the carrier tape unwinds from the reel.
- 6.6 Components on a reel.
- 6.6.1 LG = 500
- 6.6.2 LH = 500
- 6.6.3 LS = 500
- 6.7 The tape will be prevented from unreeling by winding a paper tape around the reel and fixing with adhesive tape.
- 6.8 All reels will display:
1. Device Type
 2. Quantity on reel
 3. Date code
 4. A static hazard warning label
 5. CML Serial Number
- 6.9 Reel packed into anti-static bubble bag then in a cardboard box, with appropriate labelling as in paragraph 6.8.
- 6.10 Ideal storage conditions are 15°C to 20°C with a relative humidity of 60% - 70%.

**Handling Precautions**

CML microcircuits are CMOS LSI devices which include input protection. However precautions should be taken, at all times, to prevent static discharges which may cause device damage.

- It is recommended that the user initially stores and transports the microcircuit in the original supplied packaging.
- At all times observe anti-static precautions including the correct use of a conductive wrist-band and cord.
- Keep benches, personnel and test equipment at the same electrical potential.
- Ensure that the microcircuit is stored and operated well away from any potential source of static discharge.
- Do not insert or remove a microcircuit from an application whilst any power remains applied.
- Whenever possible ensure that the microcircuit is inserted after all other components have been mounted.
- Do not apply signals to a microcircuit until the power supply is suitably established.